

# Bridging the Gap Between Nanophotonic Waveguide Circuits and Single Mode Optical Fibers Using Diffractive Grating Structures\*

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In this paper, the use of diffractive grating structures to efficiently interface between a single mode fiber and a high index contrast waveguide circuit is outlined. We show that high index contrast grating structures allow for broadband and high efficiency coupling. Since no polished facet is required on the photonic integrated circuit to interface with the optical fiber, fiber-to-chip grating couplers enable wafer-scale testing, reducing the cost for testing large scale integrated optical circuits. We show that two-dimensional grating structures can solve the problem of the huge polarization dependence of high index contrast photonic integrated circuits. Finally, an optical probe is presented, which allows testing individual components of a photonic integrated circuit, analogous to the electrical probes used in micro-electronics.

Keywords: Silicon Photonics, Fiber Interface.

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## 1. INTRODUCTION

Nanophotonic integrated circuits allow large scale integration of optical functions on a single substrate. The routing of light on these ultra-compact circuits is achieved using high refractive index contrast waveguides, since wavelength scale optical functions can be realized in this way. In order for the waveguides to be single mode, submicron waveguide dimensions are required. The mismatch between the size of the optical mode on the photonic integrated circuit and that of a single mode fiber, used to

interface with the photonic integrated circuit, is very large. Therefore a dedicated coupling structure between optical fiber and photonic integrated circuit is required for efficient fiber-chip coupling. Two main approaches are pursued to tackle this problem. In a first approach, the size of the optical mode on the chip is transformed using adiabatic taper structures. Both lateral inverted taper structures (where the optical mode is transformed to that of a low index waveguide structure on top of the nanophotonic waveguide layer)1 and three dimensional taper structures are considered. Although in principal the transformed optical mode can be matched to that of a single mode fiber, this leads to long adiabatic taper structures and to a large topography on the photonic integrated circuit, which is unwanted from a fabrication point of view. Therefore the adiabatic taper approach is often combined with a decrease in the size of the fiber mode using lensed fiber or high numerical aperture fiber. While in this way high efficiency, broadband optical coupling can be realized, the adiabatic taper approach has some disadvantages. It typically requires the use of specialty optical fiber and/or specialty fabrication techniques. Moreover, it requires a polished facet to interface with the photonic integrated circuit. While this is the standard approach of interfacing with a photonic integrated circuit nowadays, it is desirable to have a wafer-scale approach when it comes to

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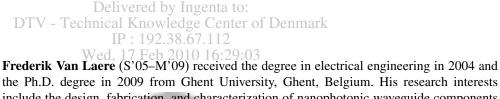
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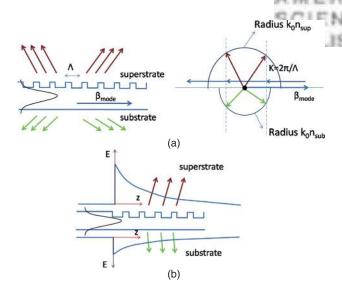
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testing large scale integrated photonic circuits, comparable to what is done in the micro-electronics world. Therefore, in this paper we will elaborate on another approach to achieve an efficient interface between fiber and nanophotonic integrated circuit, by means of diffractive grating structures. We will show that in this way wafer-scale testing of high index contrast nanophotonic waveguide circuits is feasible and that a high efficiency, broadband interface is realized, which even allows tackling the problem of the huge polarization dependence of high index contrast waveguide structures. The use of diffractive grating couplers will be demonstrated on the silicon-on-insulator high index contrast waveguide platform.

# 2. FIBER-TO-CHIP GRATING COUPLER: OPERATION PRINCIPLE AND LIMITATIONS

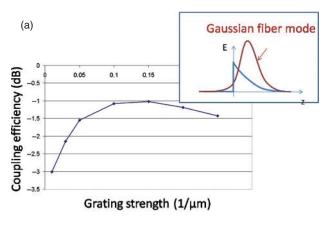
In its simplest form, a fiber-to-chip grating coupler consists of a periodic structure defined in a waveguide, realized by etching in a high index waveguide layer or by using deposition techniques. Light impinging on the periodic structure will diffract from the grating under an angle

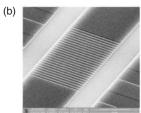


**Fig. 1.** Bragg diffraction from a waveguide grating structure to different diffraction orders (a) and the (in first order) exponential decay of the diffracted field strength along the propagation direction of the optical mode (b).

determined by the projected Bragg condition, as shown in Figure 1(a). By properly designing the grating structure, diffraction can be limited to a single diffraction order. Placing a single mode fiber under the appropriate angle with respect to the surface of the chip, allows efficient coupling between the optical fiber and the photonic integrated circuit.

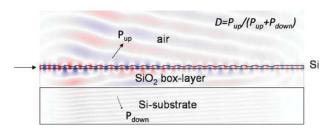
In a first order approximation, the field diffracted from a uniform grating structure is exponentially decaying along the propagation direction of light (see Fig. 1(b)). Since efficient interfacing with a single mode fiber is envisaged, the coupling length of the grating (i.e., the 1/e decay length of the diffracted field) needs to be matched with the core size of a single mode fiber, being about 10  $\mu$ m. This implies that a strong index contrast in the grating is required, which can easily be obtained in a membranelike waveguide system as silicon-on-insulator. Since the field profile is exponentially decaying, the overlap between the Gaussian mode profile of the optical fiber and the diffracted field is limited, thereby limiting the coupling efficiency between fiber and chip to about -1 dB, for an optimal grating strength of about  $0.14/\mu m$  as shown in Figure 2(a). This corresponds to a coupling length of 3.8 µm. This fiber-to-chip coupling efficiency assumes that all the light from the grating is diffracted towards the optical fiber. A grating coupler based on this design principle for a wavelength band around 1.55 µm realized on the SOI waveguide platform is shown in Figure 2(b). It consists of 70 nm deep grooves on a 630 nm pitch, etched in a 220 nm silicon waveguide layer (on a 2  $\mu$ m buried oxide layer). Since high index contrast waveguide structures are used, these one-dimensional grating structures are very polarization dependent and can only be optimized to obtain high performance for a single polarization. Experimentally, -6 dB to -5 dB coupling efficiency is obtained at a wavelength of 1.55  $\mu$ m from these structures, for transverse electric (TE) polarized light when tilting the fiber 10 degrees off vertical. This is significantly lower than the theoretical -1 dB limit. This is due to the fact that in these classical grating coupler structures, also a considerable amount of light is diffracted towards the substrate as shown in Figure 3, limiting the directionality D of the grating (being the ratio of the power diffracted towards the optical fiber and the total power diffracted from the grating structure). Thereby the fiberchip coupling efficiency  $\eta$  is limited to  $\eta = 0.8D$ . Since





**Fig. 2.** Influence of the grating strength on the maximum obtainable fiber coupling efficiency, due to the overlap between the Gaussian fiber mode and the exponentially decaying diffracted field profile (a) and an SEM image of a realized uniform diffraction grating, etched 70 nm in a 220 nm Silicon-on-Insulator waveguide structure (b).

the directionality for basic grating coupler structures is about 50%, the fiber-chip coupling loss is mainly related to this limited directionality. Therefore, in the remainder of this section we will primarily focus on the design, fabrication and characterization of highly directional diffraction gratings. A further improvement in fiber coupling efficiency can be obtained by using non-uniform diffraction gratings in order to better match the diffracted field profile to that of the Gaussian fiber mode.<sup>2</sup> This however substantially complicates fabrication, since nanometer-scale dimensional control is required over each individual grating line, making the definition of the grating structures using CMOS compatible deep UV lithography hard. Due to the strong polarization dependence of high index contrast structures, the devices described in the remainder of this section were only optimized and characterized for TE



**Fig. 3.** Field plot of the diffraction of light from a uniform grating structure showing the limited directionality of basic grating structures which limits the fiber-to-chip coupling efficiency.

polarized light. The realization of polarization independent fiber-chip coupling will be discussed later on in this paper.

High directionality gratings can be obtained in a number of ways, schematically outlined in Figure 4. One way to achieve high directionality is to integrate a bottom mirror underneath the diffractive grating structure. This can be a metallic mirror<sup>3</sup> or a dielectric DBR mirror.<sup>4</sup> Even the use of a high index substrate as a carrier for the membrane waveguide structures (as is the case for a siliconon-insulator waveguide structure) can already positively impact the fiber coupling efficiency. The mirror redirects the downwards diffracted light towards the optical fiber,

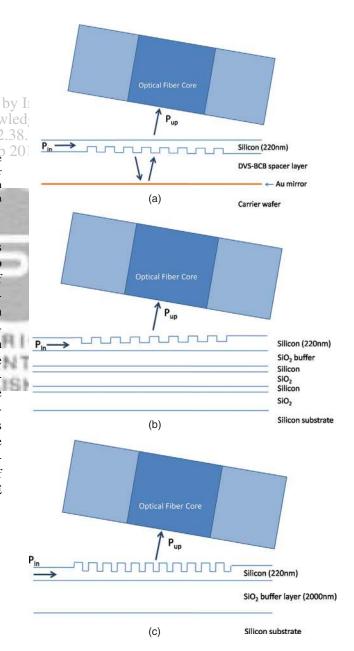
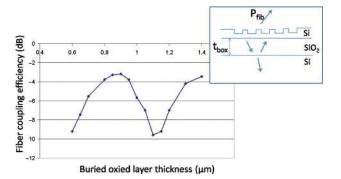
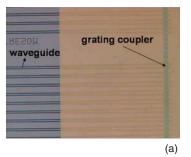


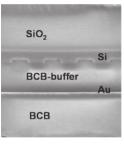
Fig. 4. Highly directional diffractive grating structures based on a metallic bottom mirror (a), a dielectric DBR mirror (b) and a silicon overlay (c).

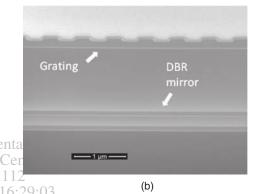
where it interferes with the directly upwards diffracted beam. Since this is an interference based enhancement of the grating directionality, the phase of the redirected beam needs to be well controlled, since it will determine the coupling strength of the grating/mirror combination and hence the coupling efficiency to optical fiber. This is illustrated in Figure 5, where the influence of the thickness of the buried oxide, separating the silicon waveguide layer from the silicon substrate, on the fiber coupling efficiency of the basic SOI grating coupler (shown in Fig. 2(b)) is depicted. This buried oxide thickness determines the phase of the redirected beam and thereby the fiber coupling efficiency. Experimentally we have realized high efficiency one-dimensional grating structures based on a gold bottom mirror and using a two-pair Si/SiO<sub>2</sub> DBR stack. The gold bottom mirror based devices were realized using a DVS-BCB wafer bonding approach. In this case the basic grating structures with limited directionality shown in Figure 2(b) were used. On top of these by Ingenta diffraction gratings a DVS-BCB spacer layer (n = 1.54) veloce Cer of 840 nm and a gold mirror of 50 nm were defined 38.67.11 after which the whole device structure was bonded on a 2010 16:29:03 carrier wafer and the original silicon carrier wafer was removed in order to access the fiber couplers. The fabricated structures are shown in Figure 6(a). In this way −1.6 dB coupling efficiency was obtained. While these grating structures based on metallic bottom mirrors allow for high efficiency fiber coupling, the fabrication process is not directly transferable to a CMOS line, since it requires the use of non-standard bonding processes. Therefore a Si/SiO<sub>2</sub> DBR based approach was pursued since it allows for fabrication in a CMOS line using standard processes. The device structure is shown in Figure 6(b). The fiber couplers were fabricated on a 200 mm Si wafer. First a 1  $\mu$ m SiO<sub>2</sub> isolation layer is deposited on a bare Si wafer. Then the Bragg mirror, consisting of two 112 nm layers of amorphous silicon and a 267 nm layer of SiO<sub>2</sub> are deposited. On top of the Bragg mirror a 1.48  $\mu$ m of buffer



**Fig. 5.** Simulation of the influence of the buried oxide layer thickness  $t_{\rm box}$  on the fiber-to-chip coupling efficiency at a wavelength of 1.55  $\mu$ m (TE polarization). The grating period is 630 nm, the grating is etched 70 nm in the 220 nm silicon waveguide layer and the fiber is tilted 10 degrees from the surface normal.





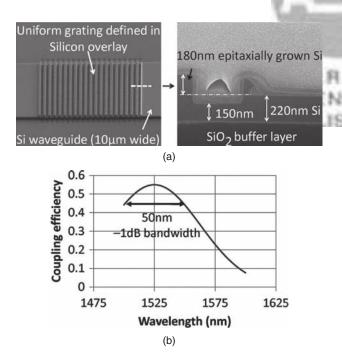


**Fig. 6.** Experimental realizations of high efficiency fiber-to-chip coupling structures: A gold bottom mirror grating structure (a). Reprinted with permission from [3], F. Van Laere et al., *J. Lightwave Technology* 25, 151 (2007). © 2007, IEEE, and a Si/SiO₂ DBR bottom mirror grating structure (b). The fiber-to-chip coupling efficiency is −1.6 dB for both structures.

SiO<sub>2</sub> and a silicon layer were deposited. The grating couplers and waveguides were fabricated using 193 nm optical lithography and dry etching. Again, the basic grating structure was used, in order to compare the metallic mirror and DBR mirror approach. The experimentally obtained coupling efficiency is comparable to the metallic mirror approach, illustrating that in an all-dielectric approach also high efficiency coupling structures can be realized.

While the use of a bottom mirror significantly increases the fiber-chip coupling efficiency, it requires dedicated substrates or dedicated processing steps. Intrinsically improving the directionality of the grating structures would allow realizing high efficiency fiber-to-chip coupling independent of the substrate. By optimizing the design of the diffraction grating, this can be achieved. The use of blazed gratings allows increasing the directionality of the grating structure, but these structures are not compatible with CMOS fabrication. In Figure 4(c), a grating coupler structure with a silicon overlay is presented to realize high directionality gratings.<sup>5</sup> The silicon overlay gives an additional degree of freedom to design the grating structure, such that it intrinsically has a high directionality and a coupling strength that is well matched to interface with a single mode fiber. By optimizing the design of this grating structure, -1 dB coupling efficiency can be obtained for a uniform grating structure on a standard SOI waveguide wafer, almost independent of the buried oxide layer thickness. This silicon overlay can be a deposited amorphous layer or epitaxially grown silicon. A prototype grating structure with epitaxially grown silicon overlay is shown in Figure 7(a). The fabricated structure consists of a uniform grating structure with a pitch of 610 nm (duty cycle of 50%). This grating is etched in a silicon layer stack of 400 nm height (220 nm silicon waveguide layer with a 180 nm thick silicon overlay epitaxially grown on top) by etching 250 nm deep slits. While the grating parameters of the fabricated grating structure deviated from the designed ones (150 nm overlay thickness and 220 nm etch depth were targeted), already -2.6 dB fiber coupling efficiency was realized in this way, by tilting the fiber 10 degrees off vertical, which is in good agreement with FDTD simulation results.6 This good correspondence between measurement and simulation makes us confident that in future optimized fabrication runs -1 dB coupling efficiency is achievable.

While a high fiber-to-chip coupling efficiency is an ledge of important issue, the optical bandwidth of the diffraction 38.67.1 grating is equally important for practical applications. 2010 1 Diffraction grating structures are typically considered to be narrow band structures, due to the strong wavelength dependence of the diffraction angle on the wavelength. This is however only the case for low index contrast gratings, where the grating length is on the order of several tens to hundreds of wavelengths. Since high index contrast grating structures are used to interface with a single mode

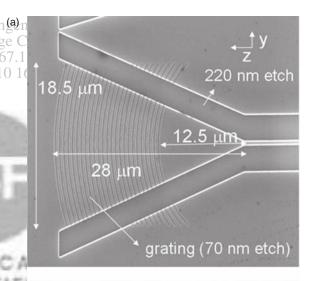


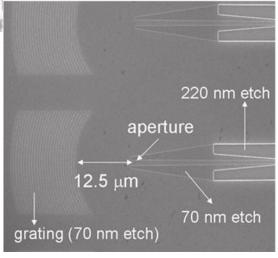
**Fig. 7.** SEM image of a fabricated grating structure with a silicon overlay, defined using silicon epitaxial growth (a) and the measured fiberto-chip coupling spectrum (b) which is in good agreement with FDTD simulations. Reprinted with permission from [6], G. Roelkens et al., *Appl. Phys. Lett.* 92, 131101 (2008). © 2008, American Institute of Physics.

fiber, this also brings along a large optical bandwidth. Typically a 1 dB (3 dB) bandwidth of 30 nm to 50 nm (50 nm to 100 nm) is realized, depending on the device structure as shown in Figure 7(b).

# 3. FOCUSING GRATING COUPLERS

While the diffraction grating used to interface with the optical fiber is very compact, i.e. about the size of the core of a single mode fiber, still a long adiabatic taper is required to laterally transform the 10  $\mu$ m wide waveguide to a 0.5  $\mu$ m wide single mode waveguide. This adiabatic taper consumes significant silicon real estate, which becomes an important issue in large scale integrated optical circuits. Therefore, focusing grating structures were designed to replace the adiabatic taper.<sup>7</sup> The grating lines



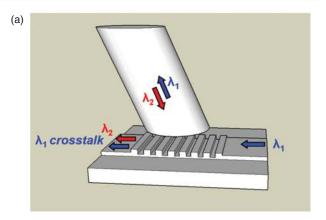


**Fig. 8.** Two implementations of a focusing grating coupler: A focusing grating in combination with a short, linear, non-adiabatic taper (a) and in (b) the light is focused by the grating onto a low contrast aperture. Reprinted with permission from [7], F. Van Laere et al., Group IV Photonics, paper ThB3 (2008). © 2007, IEEE.

of the focusing grating are parts of ellipses with a common focal point. At the common focal point the single mode waveguide is positioned. On the symmetry axis of the focusing grating coupler the pitch between the grating lines is 630 nm, as in the basic rectilinear grating configuration for TE polarized light at a wavelength of 1.55  $\mu$ m. The fiber is tilted 10 degrees off vertical. These structures allow realizing an eight-fold decrease in the length of the grating coupling structure, without having an impact on the device efficiency. The realized focusing grating coupler structures are shown in Figure 8 in two different configurations. In a first implementation, a focusing grating in combination with a short, linear, non-adiabatic taper to a 500 nm wide photonic wire is used. In a second implementation, the light is focused by the grating onto a low contrast aperture with a width ranging from 0.8 to 2  $\mu$ m. This trast aperture with a width ranging from 0.8 to 2  $\mu$ m. This low-contrast aperture was implemented in a 70 nm etch (instead of being fully etched through the 220 nm silicon waveguide layer) using the same etch step used to define by the grating lines. The lower lateral index contrast reduces reflections at the aperture. The transition from low-contrast to high-contrast waveguides is done adiabatically over a 2018  $30 \mu$ m length. The performance of both types of focusing 30  $\mu$ m length. The performance of both types of focusing grating couplers is comparable to the basic non-focusing structures: -6 dB to -7 dB coupling efficiency can be obtained.

# 4. EXTENDING THE BANDWIDTH: GRATING DUPLEXER STRUCTURES

For a set of applications, the bandwidth provided by the diffraction grating structures described above is insufficient. This is especially true for applications requiring the processing of multiple wavelength bands on the photonic integrated circuit. In these applications, the photonic integrated circuit typically has to interface with the optical fiber in two well separated wavelength bands, which have to be (de)multiplexed on the photonic integrated circuit. This is for example the case for fiber-to-thehome (FTTH) access network transceivers which require the multiplexing of a 1300 nm wavelength band signal and a 1490 nm/1550 nm wavelength band signal.8 While the basic grating structures as discussed in the previous section do not provide sufficient bandwidth for this task, the design of the grating structure can be modified in order to accommodate the efficient coupling of two wavelength bands, while at the same time providing the wavelength duplexing functionality. This can be achieved by using the two access waveguides to the grating as shown in Figure 9(a) and designing the grating period and fiber angle such that both wavelength bands are coupled in opposite directions on the photonic integrated circuit. The same mechanisms as described in the previous section to enhance the fiber coupling efficiency can be used to improve the performance of this device. In Figure 9(b), the



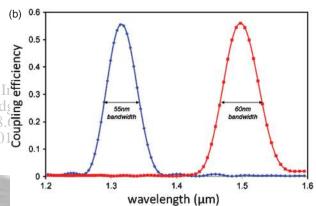


Fig. 9. The grating duplexer concept: device layout (a) and simulation of the performance of this one dimensional grating duplexer structure with silicon overlay for TE polarized light (b). Reprinted with permission from [8], G. Roelkens et al., *Opt. Express* 15, 10091 (2007). © 2007, Optical Society of America.

simulation results are plotted for an optimized duplexer grating structure for 1310 nm and 1490 nm wavelength based on a silicon overlay grating structure. -2.6 dB coupling efficiency can be obtained for both wavelength bands, while the 3 dB bandwidth for the individual bands is 55 nm and 60 nm respectively. The measurement results of a prototype duplexing structure realized by etching 70 nm deep slits in the 220 nm silicon waveguide layer thickness are shown in Figure 10(a). The period of the grating is 520 nm and the grating duty cycle is 40%. The grating consists of 20 grating periods. Index matching fluid was applied between the optical fiber facet and the grating duplexer to avoid reflections at the fiber facet and the fiber was tilted under an angle of 10 degrees. Transverse electric polarization was used. The duplexing behavior can clearly be observed. When using this component in a transceiver configuration, where one wavelength band is used for upstream communication, while the other wavelength band is used for downstream communication, the crosstalk from the transmitter port to the receiver port has to be minimized. While the intrinsic grating duplexer has a significant crosstalk of about -10 dB, this can circumvented by implementing an optical filter (e.g., an echelle

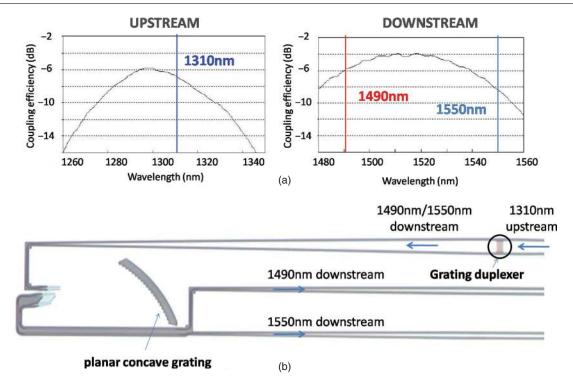


Fig. 10. Measured performance of a one-dimensional grating duplexer by directly etching the grating in the 220 nm silicon waveguide layer (a) and the use of an echelle grating structure to reduce the crosstalk levels between the upstream and downstream channels below -30 dB.

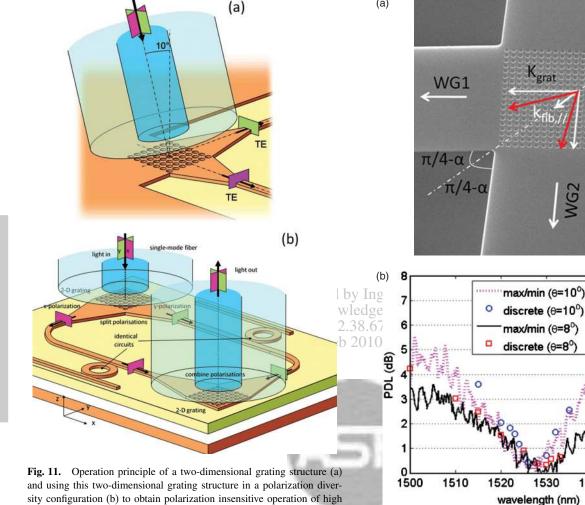
grating structure) in the downstream path, as shown in Figure 10(b). The measured residual crosstalk between the transmitter port and the receiver in this device was better than  $-30 \text{ dB.}^9$ 

# 5. TWO-DIMENSIONAL GRATING STRUCTURES—A POLARIZATION DIVERSITY SCHEME

The use of high refractive index contrast waveguide structures implies that the photonic integrated circuit behaves very differently for transverse electric (TE) and transverse magnetic (TM) polarized light. This is also the case for the one-dimensional fiber-to-chip grating coupler structures discussed in the previous sections. For practical applications often polarization independent operation of the photonic integrated circuit is required, since the polarization of the light in the optical fiber is unknown and varying over time. The use of two-dimensional grating structures allows tackling this problem using a polarization diversity configuration. This is schematically depicted in Figure 11(a). The two-dimensional grating structure can be seen as the superposition of two one-dimensional grating structures, which are identical and which are designed to efficiently couple a single polarization (i.e., TE polarized light) to the waveguide circuit. By placing these one-dimensional grating structures orthogonal to each other, hence creating a square lattice grating structure, this two-dimensional grating structure allows to efficiently interface with both polarizations of light in the

optical fiber, by coupling the orthogonal polarizations in the optical fiber to identically (TE) polarized modes in orthogonal waveguides. This approach allows realizing polarization independent operation of (intrinsically very polarization dependent) high index contrast waveguide structures by having two identical photonic integrated circuits in both arms of the polarization diversity configuration as shown in Figure 11(b). While achieving "identical" circuits requires sub-nanometer control over the dimensions of the photonic integrated circuit waveguides, this can be achieved using state-of-the-art 193 nm deep UV lithography. The operation principle of the twodimensional grating structure as described above is only valid when the fiber is perfectly perpendicular to the photonic integrated circuit. While a diffraction grating can be designed to diffract light perfectly perpendicular to the chip surface, this is always associated with a strong second order Bragg reflection from the grating structure, which is not wanted for practical circuits. Therefore the fiber needs to be slightly tilted with respect to the surface normal and directed along the symmetry axis of the twodimensional grating structure. While this allows avoiding the second order reflection, it also requires that the optical waveguides are slightly tilted inwards, as is clear from the projected Bragg condition as shown in Figure 12(a). The basic two dimensional grating structure consists of a square lattice of holes (diameter of 390 nm) on a pitch of 605 nm, which are etched 70 nm deep in the silicon waveguide layer. The fiber is tilted 10 degrees off vertical to avoid second order Bragg reflection. Therefore the optical

(a)



access waveguides are tilted 3.1 degrees inwards. In practice the tilting of the optical fiber off vertical implies that the polarization independent behavior only works over a limited wavelength range, as shown in Figure 12(b), where the measured wavelength dependence of the polarization dependent loss of a two-dimensional grating structure is plotted. The polarization dependent loss can be kept below

1 dB over a wavelength range of 15 nm.

index contrast waveguide structures.

While the two-dimensional grating structure is an elegant way of solving both the fiber-chip coupling problem and the polarization dependence of photonic integrated circuits, the limited bandwidth over which low polarization dependence is obtained can be an issue in practical applications. One way to tackle the problem is to improve the design of the grating structure (shape of the holes, grating lattice structure) to obtain better polarization insensitivity. This however requires extensive three-dimensional FDTD simulations which require a lot of computational resources. At the moment it is not yet clear what the ultimate limit of the performance of this type of devices is in terms of polarization dependent loss.

Fig. 12. Influence of the tilt of the optical fiber along the symmetry axis of the two-dimensional grating on the orientation of the access waveguides (a) and wavelength dependence of the polarization dependent loss (PDL) due to the tilting of the optical fiber (b).

1540

1550

Since the two-dimensional grating structures can be considered as a superposition of two one-dimensional grating structures, it is relatively straightforward to also design a focusing polarization diversity grating structure. This allows realizing a polarization agnostic interface between the optical fiber and the photonic integrated circuit on a drastically scaled silicon real estate area as shown in Figure 13. The performance of the device in terms of efficiency and polarization dependent loss is comparable to that of the standard two-dimensional grating structures.<sup>10</sup>

# 6. THE OPTICAL PROBE

As discussed above, diffractive grating structures allow efficient interfacing with an optical fiber. Since they do not require a polished facet, wafer scale testing of the complete photonic integrated circuit can be done, using the circuit input/output grating couplers as the testing sites.

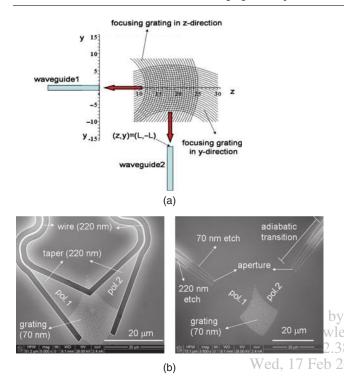


Fig. 13. Schematic of the construction of a two-dimensional focusing grating coupler as the superposition of two one-dimensional diffraction gratings (a) and the experimental realization of these focusing grating structures in two implementations, as in the case of the one-dimensional focusing grating coupler (b). Reprinted with permission from [10], F. Van Laere et al., Focusing Polarization Diversity Grating Couplers in Siliconon-Insulator, accepted for publication in Journal of Lightwave Technology. © 2009, IEEE.

This approach however does not allow testing of the individual components on the photonic integrated circuit, since implementing grating couplers at the input and output of the individual components would prevent the complete circuit from working. Testing individual components requires some sort of optical probe, analogous to the electrical probes commonly used in micro-electronics, which allow accessing the pads of individual components on an integrated circuit. These optical probes can be realized by defining a diffraction grating not on the waveguide circuit but on the facet of the optical fiber.<sup>11</sup> In Figure 14 the method to define this grating structure is outlined. A gold grating was defined on a fiber surface using a nano-imprint technique. First, the fiber with UV-curable resist is aligned over the specially prepared mold carrying the 10 by 10  $\mu$ m gold grating pattern in the trenches of the mold. Upon attachment, the cavities are filled and the resist is UV cured. Finally, the mold is released. The metal grating is now attached to the fiber, due to the fact that the mold was covered with an anti-stiction film prior to gold deposition. By using gold as the grating material, a high refractive index contrast is obtained. A fabricated optical probe is shown in Figure 14. This way efficient coupling between the optical probe and the photonic integrated circuit can be

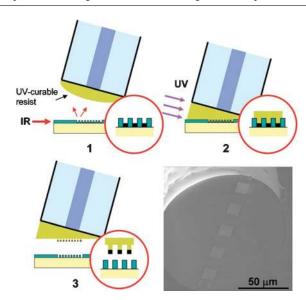


Fig. 14. Schematic of the fabrication process for the optical probe based on nano-imprint lithography and an SEM image of a fabricated optical probe. Only the center grating covers the core of the single mode fiber. Reprinted with permission from [11], S. Scheerlinck et al., *Appl. Phys. Lett.* 92, 031104 (2008). © 2008, American Institute of Physics.

obtained. Experimentally 15% coupling efficiency between a single mode fiber probe and a 3  $\mu$ m wide photonic integrated circuit was realized for TE polarized light at 1.55  $\mu$ m wavelength. The grating consisted of 20 nm thick gold stripes on a 630 nm pitch. The realization of this optical probe can pave the way to wafer-scale testing of high index contrast large scale integrated waveguide circuits.

# 7. CONCLUSIONS

Photonic integrated circuits have tremendous benefits over their discrete counterparts. Especially the use of high index contrast waveguide structures for photonic integrated circuits allows large scale integration of optical functions on a single substrate, reducing the cost, size and weight of the devices, while improving their performance. The interfacing of these scaled optical circuits with an optical fiber and the wafer-scale testing of the integrated circuits is one of the most important aspects for bringing high index contrast waveguide structures from research to practical applications. In this paper we have outlined the use of diffraction gratings to achieve this fiber/chip interfacing and wafer-scale testing. We have shown that high efficiency coupling can be achieved and that the problem of the huge polarization dependence of high index contrast waveguide systems can be circumvented by using a two-dimensional grating coupler approach. The extension of the bandwidth of the grating couplers for applications which require the fiber-chip coupling of two wavelength bands is described. Finally, in order to go to real waferscale testing of photonic integrated circuits, an optical

probe is presented which allows probing each individual component of the photonic integrated circuit.

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